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# Research Problems for DIA-CoEs





# Introduction

DRDO is funding multi-institutional and multi-disciplinary directed research projects to Academia and National Research Institutes to develop cutting edge defence technologies. The funding is focused on translational research for developing the crucial and futuristic technologies in defined research domains through a network of DRDO Industry Academia – Centre of Excellences (DIA-CoEs) at premier and capable academic institutes and universities in the country.

To foster the research in academia, DFTM invites project proposals on problem statements in multiple areas, that will be taken up through DIA-CoEs for directed research. Received proposals will be scrutinized by DFTM and forwarded to respective DIA-CoEs as per research verticals for further evaluation.

Forms for submission are provided at [drdo.gov.in/drdo/adv-tech-center](http://drdo.gov.in/drdo/adv-tech-center)

Fully furnished project proposals shall be submitted to DFTM through [techforesight.drdo@gov.in](mailto:techforesight.drdo@gov.in)



Development of indigenous light weight multiprocessor and multi-core OS complying with guidelines of DO 297 & ARINC 653 for scheduling multiple safety critical applications on multi core/multi processor hardware environment

**Technology Area**  
Embedded Systems

**Technology Category**  
Integrated Avionics

### Brief of the Research Problem

Integrated Modular Avionics (IMA) is the need of the hour to build SWaP (Size, Weight, and Power) optimized avionics for aircrafts. Availability of reliable COTS hardware with multi core or multi processors enables deployment of multiple avionics applications such as navigation, flight control, weapon/payload management, ground communication, etc. in a single box. However, achieving safe separation (both spatial and temporal) among different applications and meeting the safety and certification requirements poses a big challenge. Though COTS hypervisors and multi-core Operating Systems are available, they are of foreign origin, heavy weight and opaque. Hence, the need for an indigenously developed light weight multi-core OS which can be used for various avionics applications for manned and unmanned aircrafts.

### Major Objectives

- Indigenous, light weight multi-core and multiprocessor OS complying to DO-297 and ARINC 653 guidelines
- Complete spatial and temporal separation among the applications hosted
- Highest available standard of safety through compliance to DO-178C Level A and CAST32A guidelines
- Provision to host multiple applications (4 or more) of varying criticality. Time and resource allocation specification through XML file.
- APIs providing complete abstraction from hardware and IO layer
- APIs facilitating deterministic and guaranteed inter-application communication
- Provisions for monitoring of health and resource usage of applications
- Provision to restart a failed application through checkpoints or other mechanism
- Utilities for applications such as logging, file IO, timing, timed waits, event notification (based on IO, messages, etc)
- Framework for developing the BSP (Board Support Package) and porting the OS to various hardware (at least Power PC and ARM architecture to be supported at the time of completion)

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### Expected Deliverables

- The multi-core and multiprocessor OS along with source code (C or C++) with ready support for Power PC and ARM
- Documentation on requirements, design, software configuration index, test designs, test cases and procedures, etc. as required to facilitate DO-178C certification at Level A (Structural coverage is optional)
- A COTS hardware with 2 processors each with 2 or more cores (either Power PC or ARM), at least 2 serial channels, 4 or more Discrete inputs and outputs, 4 or more analogue inputs and outputs to demonstrate the OS
- At least 2 applications involving IO and inter-application communication for demonstration of scheduling, spatial and temporal separation and all other features
- One set of tool chain (compiler, linker, etc.) to be able to recreate the build
- Demonstration of the OS and sample applications
- User guide containing steps to compile, build, and host applications, API documentation, format for specifying time and resource usage by applications
- Formal verification design and results at design or code level to prove that OS satisfies safety requirements (desirable)

### Figures of Merit



| S no | Parameter                                                                | Value         |
|------|--------------------------------------------------------------------------|---------------|
| 1    | Ability to host and schedule multiple applications                       | 4 or more     |
| 2    | Efficiency in terms of execution time                                    | 5 % or less   |
| 3    | Lights OS - Memory usage inclusive of instruction and code               | $\leq 0.5$ MB |
| 4    | Deterministic Scheduling - low jitter in expected scheduling periodicity | $< 1$ %       |
| 5    | Ability for granular scheduling (in milliseconds)                        | $\leq 1$ ms   |



Automated material classification using a combination of spatial & textural features and generation of Multi-Sensor Data Fusion (MSDF) at pixel/data/decision level using High (sub-meter) Resolution Satellite Imagery for Imaging Sensor scene creation

### Technology Area

Hardware In Loop Simulation

### Technology Category

Flight Simulation

### Brief of the Research Problem

Flight Simulators require high fidelity & detailed large gaming areas of the order of 500km X 500 km or more, typically centered around an airfield. Currently available COTS tool have technology for material classification that are based on pixel colour of the satellite imagery used. However, the technology to make use of inherent textural features (like energy, entropy, contrast etc.) for material classification is currently not available. In addition to creation of visual scenes, it is also required to create correlated imaging sensor scenes like EO/IR & Synthetic Aperture Radar (SAR) scenes that are available to the pilots/operators training in the Flight Simulators. With advances in AI and fast image processing algorithms for generation of textural features, it is very much possible to extract such features for the entire large gaming area with minimal interaction on the part of the human operator. It is proposed to automatically classify the gaming area into different materials, using a combination of colour and textural features derived from the satellite imagery. With the usage of Multi-Sensor Data Fusion (MSDF) in various airborne systems there is a requirement to simulate the same in Flight Simulators to effectively train the users (Pilots/Sensor Operator) on the utilization of MSDF. Hence, it is also proposed to generate fused outputs of optical and imaging sensor views to generate MSDF outputs by using a suitable weighing/combination of input data. The implementation can also provide a basis for comparing MSDF outputs generated at different levels (pixel/data/decision levels). The material classified and synthetically created MSDF outputs can be integrated with visual & sensor scenes using in Flight Simulators for more accurate and effective training.

### Major Objectives

- Automatic classification of the gaming area into different materials, using a combination of colour and textural features derived from the satellite imagery
- Generation of fused outputs from optical and imaging sensor views to generate Multi-Sensor Data Fusion (MSDF) outputs by using a suitable weighing/combination of the input scenes

### Expected Deliverables

- Algorithms for Automatic classification of the gaming area into different materials, using a combination of colour and textural features derived from the satellite imagery, for usage in Flight Simulators
- Algorithms for Generation of fused outputs from optical and imaging sensor views to generate Multi-Sensor Data Fusion (MSDF) outputs by using a suitable weighing/combination of the input scenes for usage in Flight Simulators



# Radar Waveforms for Low Probability of Intercept (LPI) Radar

## Technology Area

Radar

## Technology Category

LPI Radar

## Brief of the Research Problem

Design, Development and Simulation of the waveforms for Pulse Doppler Radars, which are: 1. Difficult to detect/identify by Radar Warning Receiver (RWR) 2. Difficult to regenerate (by Jammer) in the battlefield i.e. random in nature (Ex: Noise or pseudorandom signals etc.) 3. Doppler tolerant in nature for detection and tracking of targets like Fighter Aircrafts, UAVs, Drones etc. (Max target speed up to 1000 m/s (> 03 Mach) 4. Waveform bandwidth can be up to 5/10 MHz 5. Minimum deterioration in radar's performance in comparison to conventional radar waveforms such as Frequency (LFM) / Phase (P4 codes) Modulation.

## Major Objectives

- Identification and Simulation of LPI waveforms
- Simulation and Analysis of the identified LPI waveforms on the radar's performance with respect to the existing waveforms such as LFM and P4 codes
- Comparison of Receiver Operation Characteristics (ROCs) for various target characteristics and velocity

## Expected Deliverables

Software programs (Example: MATLAB/ Octave/ any Open Source S/w codes) for generation, simulation and analysis of LPI waveform's coefficients

## Figures of Merit

| S no | Parameter                                                                                                                      | Value |
|------|--------------------------------------------------------------------------------------------------------------------------------|-------|
| 1    | Receiver Operating Characteristic (RoC) for various target characteristics (such as Swerling models) including target velocity | NA    |
| 2    | Range Doppler Characteristics in comparison with existing waveforms                                                            | NA    |



# Design and Development of 1-6 GHz True Time delay (TTD) Bidirectional Core Chip (MMIC)

## Technology Area

Electronic Devices

## Technology Category

Microwave MMIC Devices

## Brief of the Research Problem

TTD based array beam steering is frequency independent having squint free wide band operation suitable for EW applications. TTD Bidirectional corechip is basic building block for array based beam steering. This chip should have:

- TTD resolution of 1ps with maximum delay of approx. 2053 ps,
- Attenuation with resolution of 0.25dB, and maximum 31.75 dB,
- Fully integrated on-chip digital control section for high speed control and supply

## Major Objectives

- Design and Development of 1-6 GHz True Time delay (TTD) Bidirectional Core Chip (MMIC)
- TTD resolution of 1ps with maximum delay of approx. 2053 ps
- Attenuation with resolution of 0.25dB, and maximum 31.75 dB
- Fully integrated on-chip digital control section for high speed control and supply

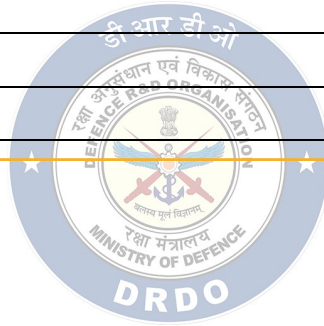
## Expected Deliverables

- Detailed Design & analysis report of complete corechip
- Development & Fabrication of TTD Bidirectional core chip
- Initial iteration: 20 nos. KGD (Known Good Dies) with on-wafer probe test report (within 2 years)
- Final iteration :100nos KGDs with on-wafer probe test report (within 9 months from initial iteration)
- Final GDSII layout files for fabrication

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## Figures of Merit

| S no | Parameter                                                                 | Value      |
|------|---------------------------------------------------------------------------|------------|
| 1    | Frequency                                                                 | 1 to 6 GHZ |
| 2    | Technology                                                                | CMOS/any   |
| 3    | TTD Step Size                                                             | 1 ps       |
| 4    | TTD range                                                                 | 2053 ps    |
| 5    | Attenuation Step Size                                                     | 0.5dB      |
| 6    | Attenuation Range                                                         | 31.5 dB    |
| 7    | Digital Interface                                                         | SPI        |
| 8    | Digital Interface Signals: Clock , Datain1, Datain2, Dataout, LatchEnable | 5 Wire     |
| 9    | State Switching Speed                                                     | >200 MHz   |
| 10   | Gain                                                                      | TBD        |
| 11   | Gain Flatness                                                             | +/-2dBmax  |
| 12   | Form Factor                                                               | MMIC       |
| 13   | Operating Temperature                                                     | -40to-85 C |
| 14   | Storage Temperature                                                       | -40to+125C |



Automated Extraction of 3D features (like buildings, bridges, metro tracks) using a combination of High (sub-meter) Resolution Mono/Stereo Satellite Imagery & DEM Data for Visual & Imaging Sensor scene creation



### Technology Area

Hardware In Loop Simulation

### Technology Category

Flight Simulation

### Brief of the Research Problem

Flight Simulators require high fidelity and detailed large gaming areas of the order of 500km X 500 km or more, typically centered around an airfield. Current technologies involve manual & semi-automated creation of densely populated 3D structures in urban areas around the airfield and creation of additional structures based on end-user requirement only in specific areas. Creation of a visual scene takes anywhere between three months to one year based on the amount of detailing and fidelity expected by the end-user. With requirement for high fidelity simulators for practicing missions in a variety of terrain and geographic locations coming up at a fast pace, it would be prudent to automate this process. With the advances in AI, computing power & image processing algorithms, it is very much possible to extract 3D features for the entire large gaming area with only minimal interaction on the part of the human developer/operator. It is proposed to automatically extract various 3D-structures like buildings, bridges & metro tracks using a combination of High resolution Mono/Stereo Satellite Imagery & DEM data. While Satellite Imagery can provide the spatial details, the information from shadows, meta-data from the satellite capturing the image, triangulation based on stereo imagery and Digital Elevation Model (DEM) data can provide the required height information of the 3D structures. The problem can be broken down into two parts:

- Part 1) Automated Creation of a Vector Map (information in points, lines, polygons) using Artificial Intelligence
- Part 2) Conversion of this vector information into an extruded 3D model/scene using AI making use of the information embedded in the vector map generated in Part 1.

### Major Objectives

Automatic extraction of various 3D-structures like buildings, bridges & metro tracks using a combination of High resolution Mono/Stereo Satellite Imagery & DEM data

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### Expected Deliverables

- Vector Map (information in points, lines, polygons) that provides the areal footprint of 3D structures in the area of interest in standard GIS vector file formats
- Extruded 3D model/scene making use of the information embedded in the vector map generated in Sl. No. 1

### Figures of Merit

| S no | Parameter                                                                                                       | Value |
|------|-----------------------------------------------------------------------------------------------------------------|-------|
| 1    | Number of 3D structures per square kilometer of gaming area in densely populated areas like metropolitan cities | 8000+ |
| 2    | Number of 3D structures per square kilometer of gaming area in medium populated areas like towns                | 2000+ |
| 3    | Number of 3D structures per square kilometer of gaming area in sparsely populated areas like small villages     | 500+  |





# Development of conduction cooled light weight electronics chassis for Man portable mountaineering

## Technology Area

Electronic Warfare

## Technology Category

Thermal Management

## Brief of the Research Problem

Four PC Boards (6U) each dissipating of 75W is placed vertically in 4 slot conduction cooled chassis for Man portable mountaineering. All the PCBs are plugged in to the horizontal mother board. The heat of the components will be transferred from PCB to chassis edge through wedge locks. Chassis edge temperature should be maintained at 71Deg C in the ambient of 55 DegC. The chassis may be designed with suitable innovative and advanced concepts in materials/cooling techniques. Constraints: i. Operational condition: -20 DegC to 55 DegC ii. Mechanical Weight of the chassis including cooling solution:  $\leq 4$  Kg iii. Noise level of the system at 1m distance:  $\leq 50$ dB. iv. Size of the chassis with cooling system: 300 (W) X 300 (D) X 240 (H) mm. (Max.) v. Man portable for mountaineering Test details: SI No. Test Specification Remarks 1 Physical inspection : Dimensional test 2 High temperature test: High Temperature test at 55 Deg C to be carried out with dummy heater loads and edge temperature to be measured. Duration: 4 hours 3 Random Vibration Frequency 20 Hz to 2000 Hz , PSD 0.02g<sup>2</sup>/Hz, Test Duration: 15 min in X & Y axes. Heaters will be ON during test

## Major Objectives

To develop conduction cooled light weight electronics chassis which dissipate 300W and to maintain 71 Deg C at chassis edge temperature

## Expected Deliverables

- Conduction cooled light weight electronics chassis (Hardware)
- Classical Design and simulation reports
- Functional test reports
- ESS reports (Test conditions are given at brief of the research problem) 1) a) Physical inspection report b) Random vibration test report c) High temperature test report

## Figures of Merit

| S no | Parameter                | Value       |
|------|--------------------------|-------------|
| 1    | Chassis edge temperature | <71Deg C    |
| 2    | Chassis weight           | $\leq 4$ Kg |



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